

Silicon carbide: electronic levels associated to irradiation

A.Cavallini

*INFN and Dipartimento di Fisica,
Università di Bologna, Italy*

Research group

- **Prof. Anna Cavallini** **HEAD of the Group**
- **Dr. Beatrice Fraboni** **PhD, Researcher**
- **Dr. Laura Polenta** **PhD, Post-Doc Researcher**
- **Mr. Antonio Castaldini** **Technical Manager**

<http://www.df.unibo.it/semiconductors>



Collaborations activated in the framework of detectors study

- **C.Canali, F.Nava** (University of Modena and Reggio Emilia - Italy)
- **P.Siffert** (EURORAD – Strasbourg- France)
- **F.Pirri, F.Giorgis** (Politecnico di Torino – Italy)



Characterization techniques

Detection and characterization of electrically active defects

- *Deep Level Transient Spectroscopy*: concentration, energy level and capture cross section of electrically active defects
- *Photoconductivity*: energy level corresponding to transitions deep level-to band (useful in wide gap materials)

Analysis of electric field distribution across detectors

- *SP (Surface Potential)*: measurement of electrostatic potential on the cleaved surface of the detector section
- *OBIC (Optical Beam Induced Current)*: photoconductivity profiles across the detector



Applications

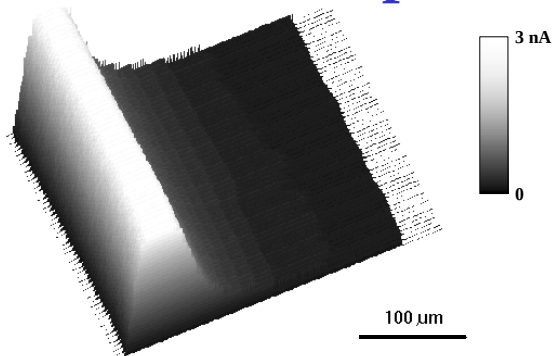
- Defective state analyses to predict trapping effects
- Electric field distribution to correlate with charge collection efficiency
- Analysis of compensation mechanisms acting in semiconductors
- Irradiation effects (radiation hardness)



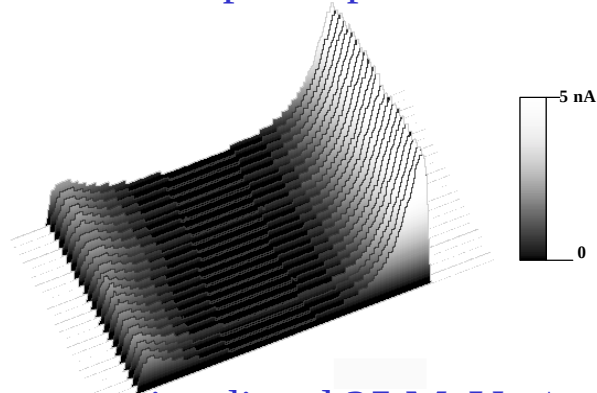
Electric field distribution

Silicon p-i-n detectors

OBIC maps



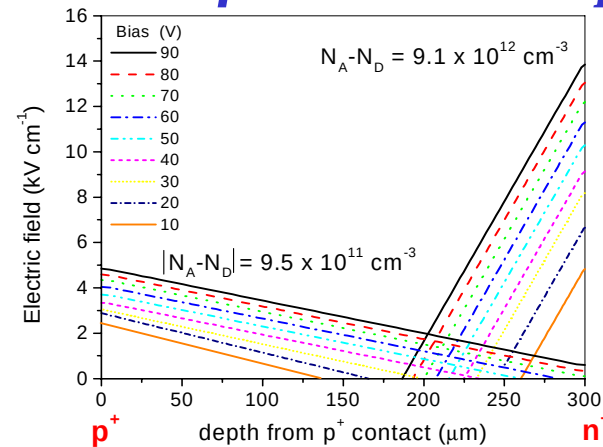
not exposed p^+-n-n^+



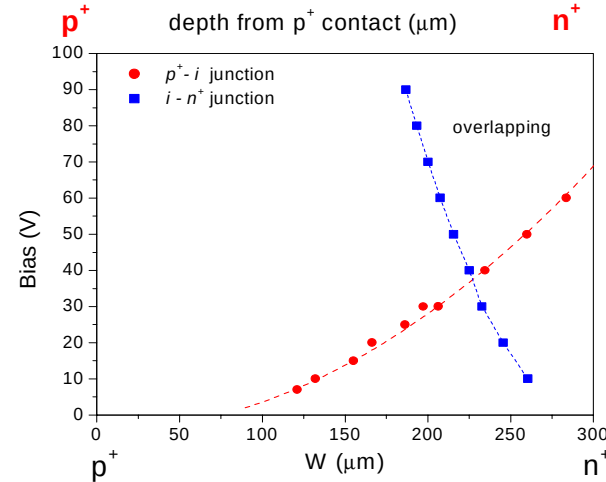
proton-irradiated 25 MeV p^+-p-n^+

$$\phi_p = 8.3 \times 10^{13} \text{ p/cm}^2$$

Surface Potential profiles



Electric field evolution after irradiation (double junction effects).



Active region evolution with bias.

[A.Castaldini, A. Cavallini, L. Polenta, C. Canali, and F. Nava, **J. Appl. Phys.** **92**, 2013 (2002)]

[A.Castaldini, A.Cavallini, L.Polenta, F.Nava and C.Canali, **Nucl.Instrum & Meth. A** **476** (2002) 550]

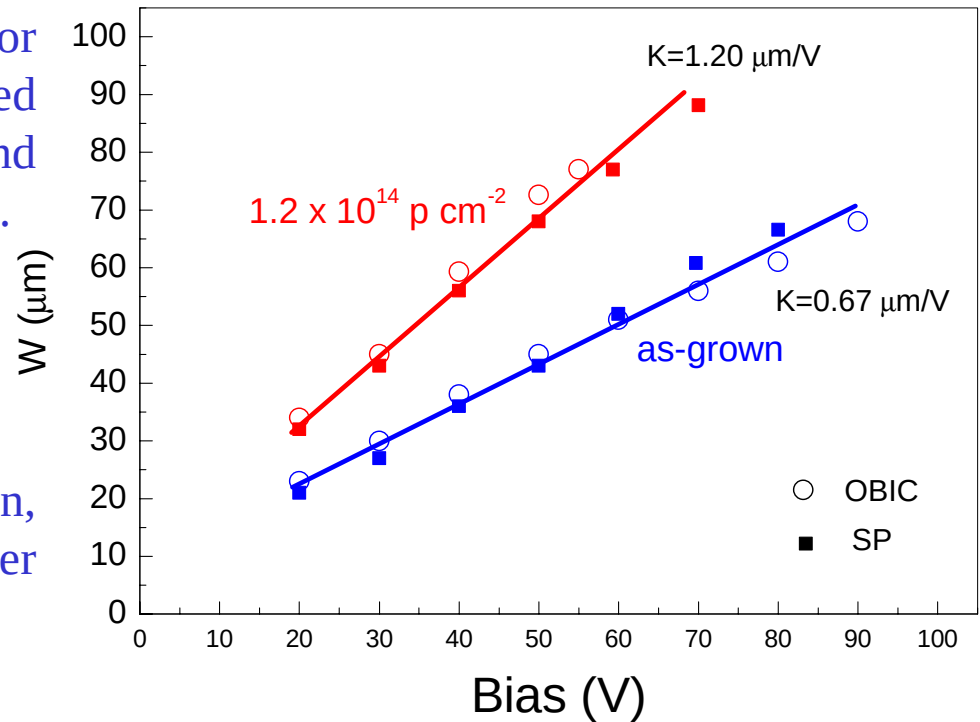
Electric field distribution

SI GaAs detectors

Surface Potential and OBIC results

Evidence of a Mott barrier like behavior due to the electric field enhanced neutralization of donors (EL2 and irradiation induced donor-like defects).

Linear evolution of depletion region, depletion rate increases after irradiation.



[A.Castaldini, A.Cavallini, L.Polenta, C.Canali and F.Nava, **Nucl. Instr. & Meth. in Phys. Res.A.** 426(1999), 192]

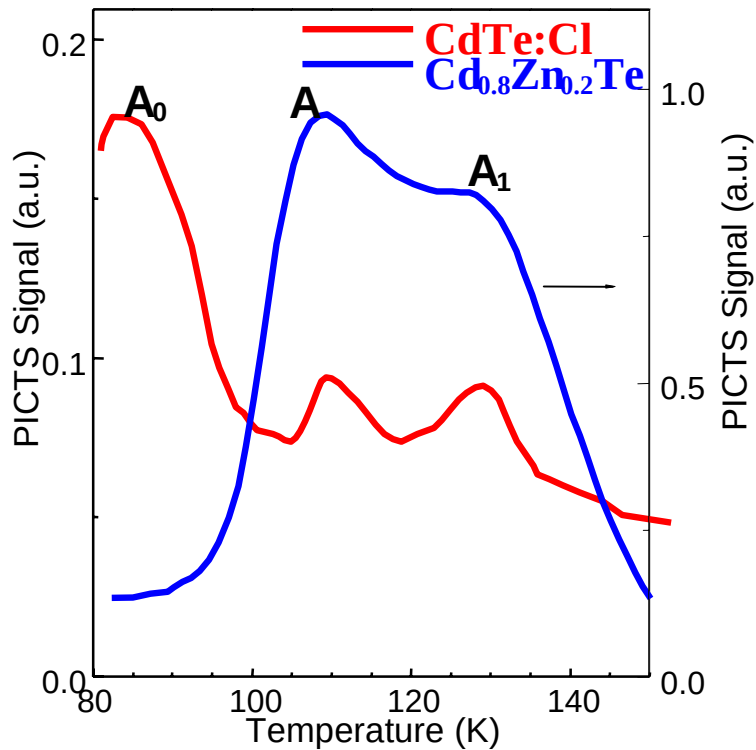
[A.Castaldini, A.Cavallini, L.Polenta, C.Canali, C.del Papa, F.Nava, **Phys.Rev.** B56 (1997) 9201]

[A.Castaldini, A. Cavallini, L. Polenta, C. Canali, and F. Nava **IEEE SIMC-X** (1999) p.153-157]

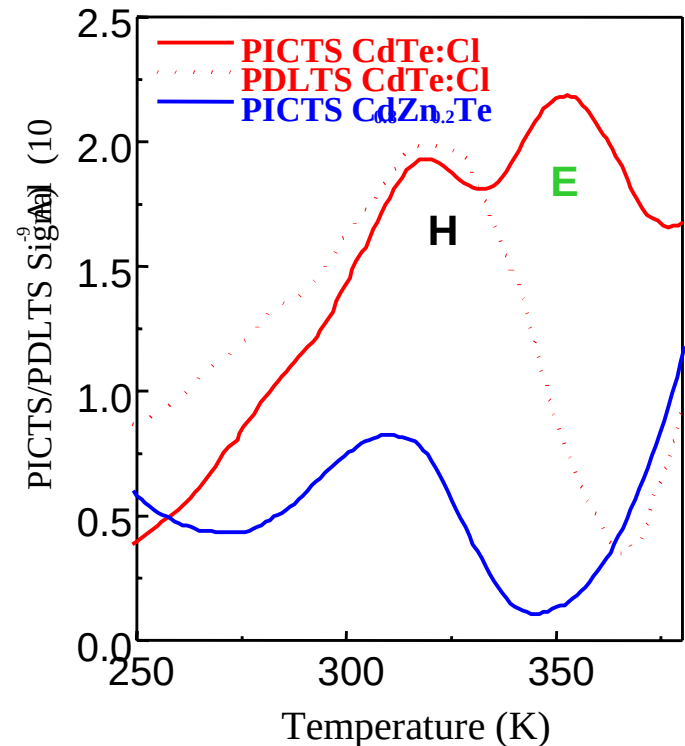


Compensation mechanisms

II-VI detectors



A₀ = Centre A, shallow acceptor (CdTe only)



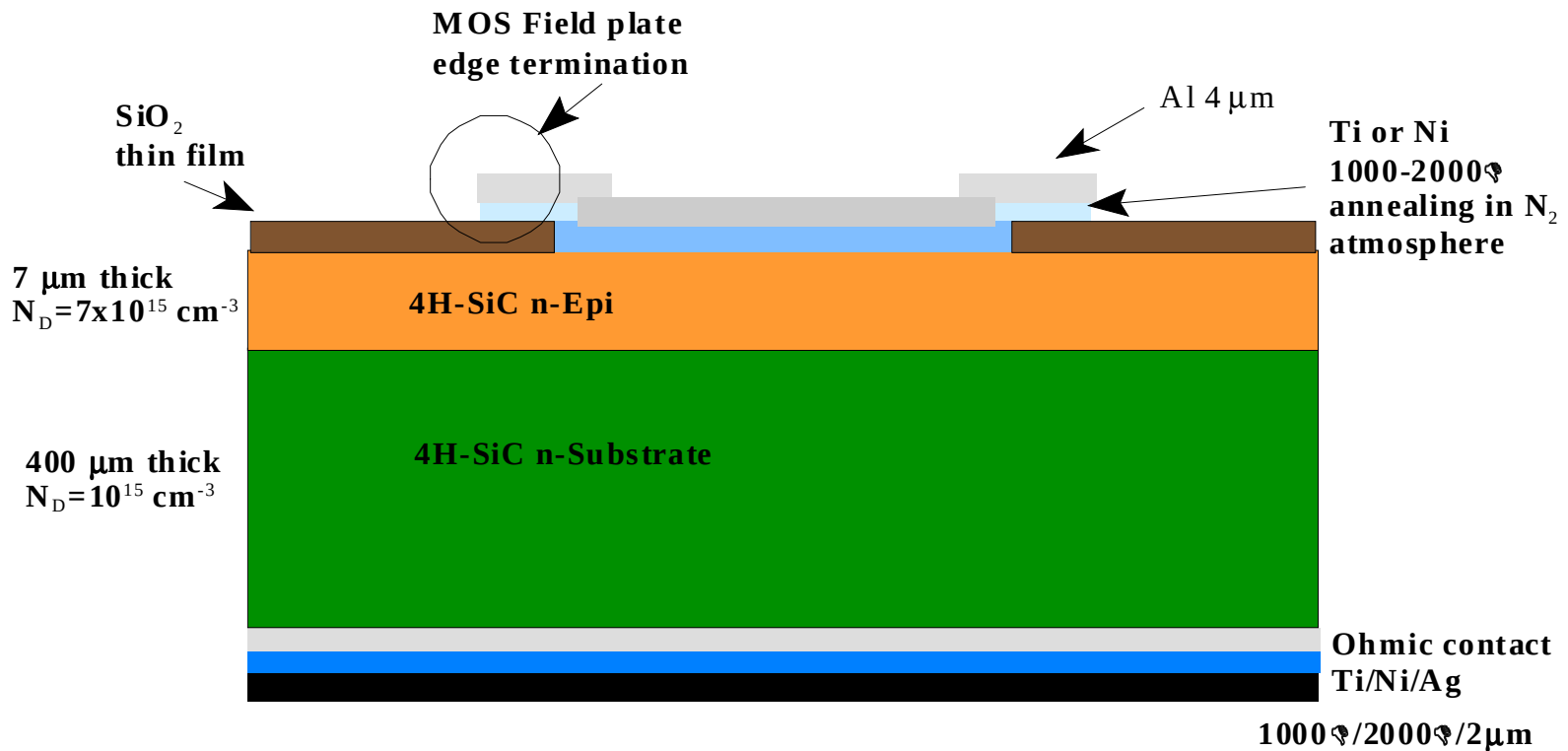
H=deep acceptor E = deep donor (CdZnTe only)

Delicate balance between shallow and deep donors and acceptors



Irradiation effects, defect detection

4H-SiC detectors

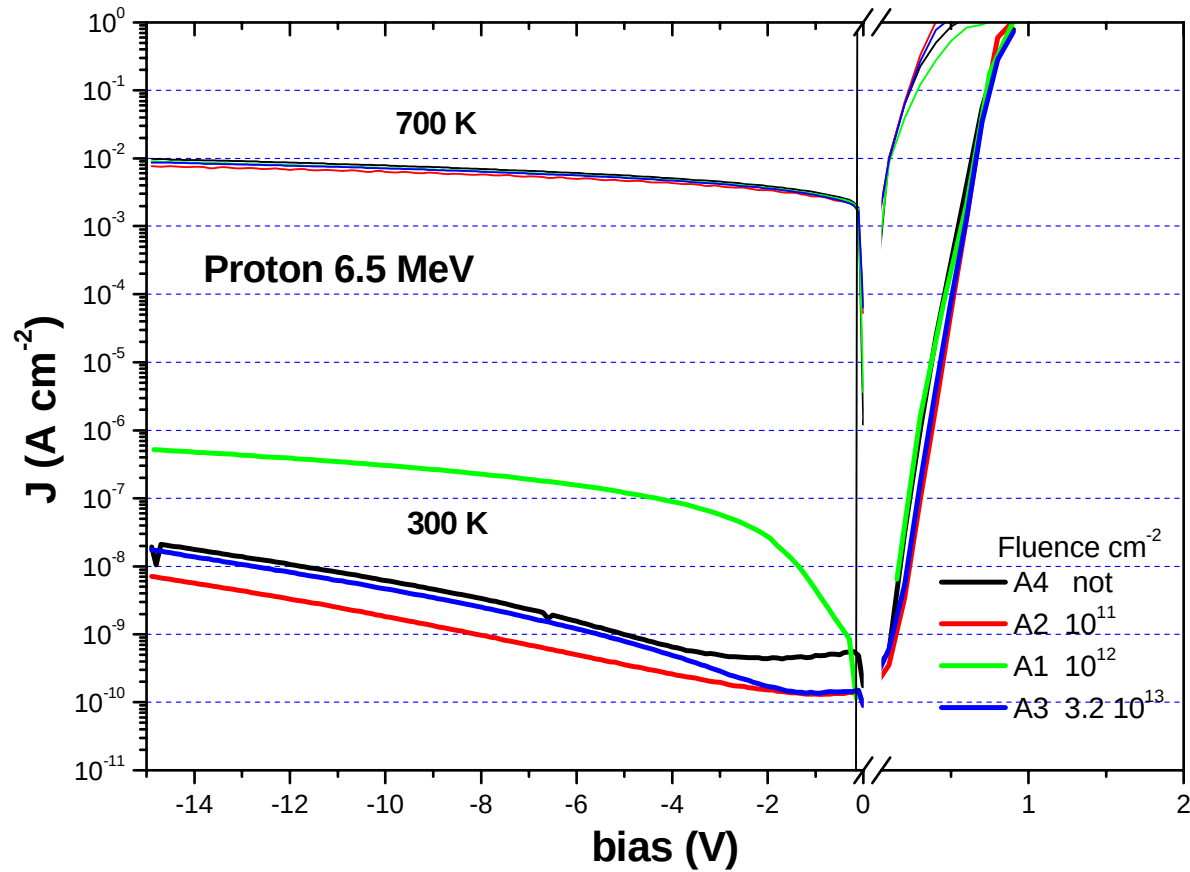


Irradiation characteristics

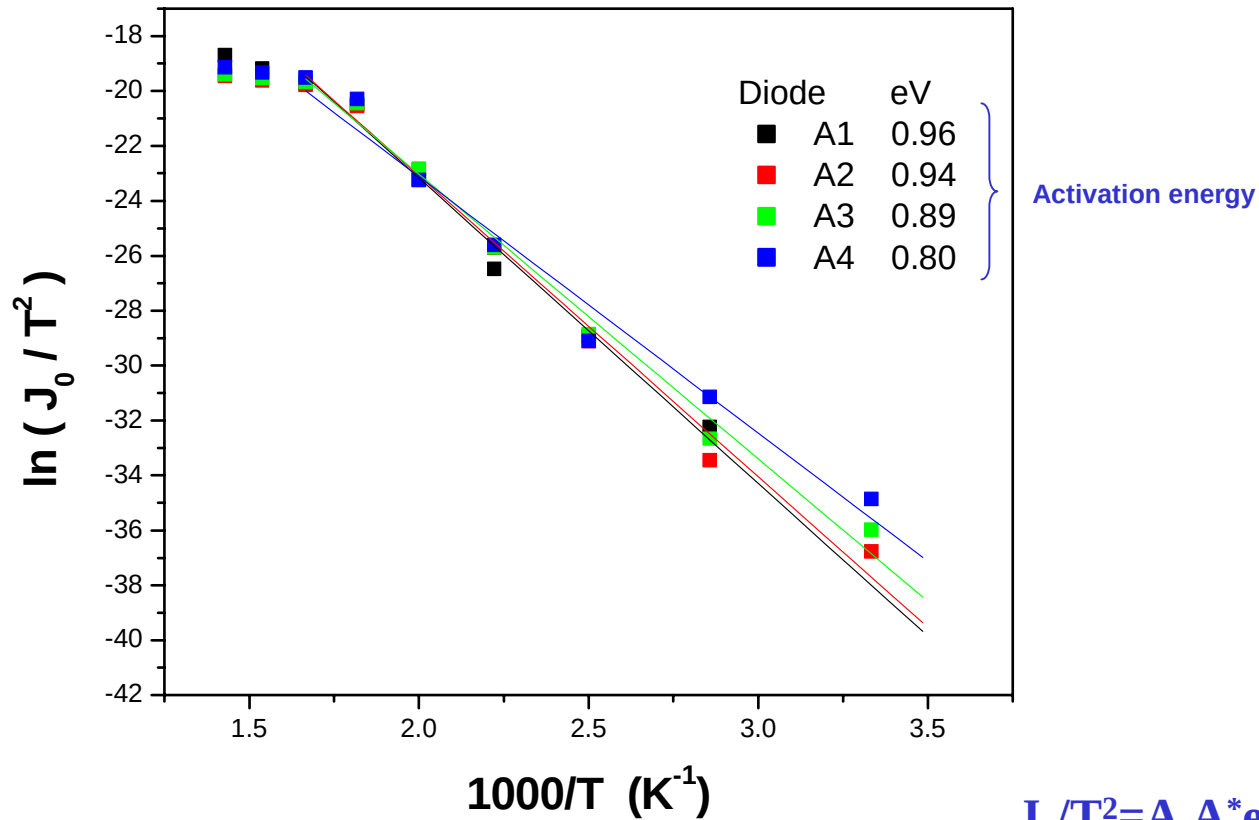
Diode	ion	Energy (MeV)	Fluence (cm ⁻²)	Schottky
A1	proton	6.5	10 ¹²	Ti + 400 C°
A2	proton	6.5	10 ¹¹	Ti + 400 C°
A3	proton	6.5	3.2 10 ¹³	Ti + 400 C°
A4	not	-	-	Ti + 400 C°
A5	not	-	-	Ti + 400 C°
C1	proton	6.5	3.2 10 ¹³	Ni
C2	alfa	12	3.2 10 ¹³	Ni
C3	proton	6.5	6.4 10 ¹³	Ni
C4	alfa	12	6.4 10 ¹³	Ni



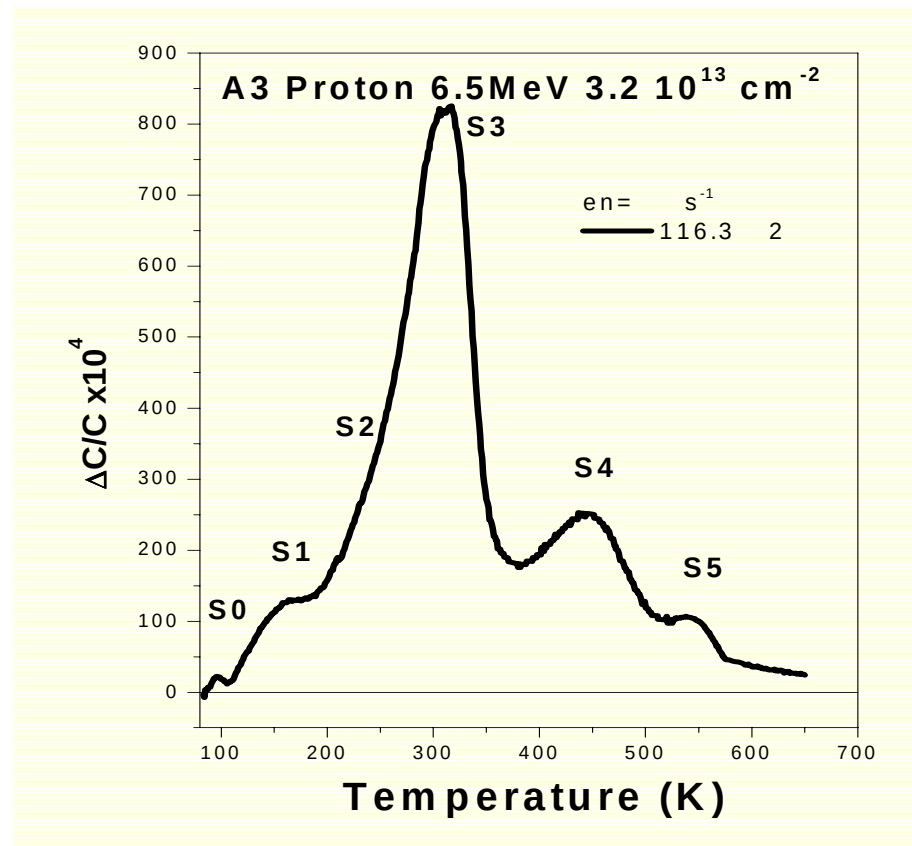
Current density for different fluences of proton irradiation Ti contacts



Arrhenius plot of the reverse current at high temperature proton irradiated diodes



$$J_0/T^2 = A A^* \exp[-q(\phi_{bn} - V)/kT]$$



Concluding Remarks

- proton irradiation only slightly changes the electrical properties of 4H-SiC Schottky diodes
- we detected 2 deep levels in as-prepared devices
- proton irradiation induces 5 levels, the density of which increases with fluence
- these deep levels are reasonably related to impurity-intrinsic defect complexes

